ASSOCIATION CONNECT	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				er both This docur level parts,	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1					Form Type * Distribute						ials and Mfg Information				
Supplier Infor	mation														
Company name*			Company unique ID			Unique ID Authority					Response Date*				
onsemi							I					2024-04-23			
Contact Name			Title - Contact			Phone - Contact*					Email - Contact*				
Product-Env-Stev	wards		Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Repre	sentative*		Title - Representative			Phone - Re	Phone - Representative*				Email - Representative*				
Product-Env-Stev	wards		Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Reques	Requester Item Number Mfr Iten		Number Mfr Item Name			Effective 1	Date	e Version Manufacturing Site		1	Veight*	UOM	Unit Type		
		NCP1096PAR2G Integrated PoE-PD integrated hot swap		nterface Controller with FET, IEEE 802.3bt, 90V	2024-04-2	.3	BE4		6	4.0	mg	Each			
Manufacturing	g Proccess Information	1								_					
Termina	Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy J-S	TD-020 MSL Rating	SL Rating Peak Process Body Temperature Max Time at Peak Temperature N						ire Num	ber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy			2		260		C	2	30	secon	ds 3				
omments															
TTENTION: MS	SL 2 Rated item requires Di	ry Pack (at	fter electrical	test)											
or more informa	tion regarding material con	position p	olease refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appli											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.3	mg	Supplier	Silicon (Si)	7440-21-3		5.3	mg
Die Attach	1.3	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.078	mg
			Supplier	Silver (Ag)	7440-22-4		1.0595	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.078	mg
			Supplier	Misc.	Proprietary Data		0.0065	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.078	mg
Die Attach Tape	1.3	mg	Supplier	Acrylic AE Copolymer	58152-79-7		0.195	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.65	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.182	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.091	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.182	mg
Lead Frame	32.6	mg	Supplier	Silver (Ag)	7440-22-4		0.0978	mg
			Supplier	Magnesium (Mg)	7439-95-4		0.0326	mg
			Supplier	Silicon (Si)	7440-21-3		0.2282	mg
			В	Nickel (Ni)	7440-02-0		0.978	mg
			Supplier	Copper (Cu)	7440-50-8		31.2634	mg
Mold Compound-Black	22.9	mg		Epoxy resin	proprietary data		1.603	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0687	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		20.839	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.3893	mg
Plating	0.5	mg	Supplier	Tin (Sn)	7440-31-5		0.5	mg
Wire Bond - Au	0.1	mg	Supplier	Gold (Au)	7440-57-5		0.1	mg